

#### **P-Channel Enhancement Mode MOSFET**

## **General Description**

The CMB100P03B is a P-channel Power MOSFET. They use advanced trench technology to provide excellent R<sub>DS(ON)</sub>. The device is therefore suitable in advanced high-efficiency switching

## **Features**

applications.

- Fast switching
- Lower On-resistance
- 100% EAS Guaranteed
- Simple Drive Requirement

#### **Product Summary**

BVDSS	RDSON	ID
-30V	7.5mΩ	-100A

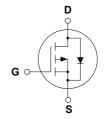
### **Applications**

- DC-DC Converters
- Motor control
- LED controller

## **TO-263 Pin Configuration**







#### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	-30	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current	-100	А	
I <sub>D</sub> @T <sub>C</sub> =100 ℃	Continuous Drain Current	-59	А	
I <sub>DM</sub>	Pulsed Drain Current	-400	А	
EAS	Single Pulse Avalanche Energy <sup>1</sup> 289		mJ	
P <sub>D</sub> @Tc=25℃	Total Power Dissipation 90		W	
T <sub>STG</sub>	Storage Temperature Range -55 to 175		${\mathbb C}$	
$T_J$	Operating Junction Temperature Range -55 to 175		${\mathbb C}$	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Junction-to-Ambient		62.5	°C/W
$R_{ heta JC}$	Junction-to-Case		1.6	°C/W

# **CMB100P03B**



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# Electrical Characteristics (T $_{J}$ =25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-30			V
D	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A		6.5	7.5	- mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A		10.5	12	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=-250uA$	-1		-2.5	V
1	Drain-Source Leakage Current	$V_{DS}$ =-30V, $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C			-1	uA
I <sub>DSS</sub>		$V_{DS}$ =-30V, $V_{GS}$ =0V , $T_J$ =125 $^{\circ}$ C			-50	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-10V, I <sub>D</sub> =-10A		18		S
Qg	Total Gate Charge	\\ - 15\\ \ \ - 500		31		
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}$ =-15V, $I_{D}$ =-50A $V_{GS}$ =-4.5V		11		nC
$Q_{gd}$	Gate-Drain Charge	7 00 110 1		10		
$T_{d(on)}$	Turn-On Delay Time			9		
Tr	Rise Time	$V_{DD}$ =-15V, $V_{GS}$ =-10V, $R_{G}$ =3.3 $\Omega$		10		
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-15A		116		ns
T <sub>f</sub>	Fall Time			23		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V , f=1MHz		3700		
Coss	Output Capacitance			350		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			300		

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	−−V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-100	А
I <sub>SM</sub>	Pulsed Source Current				-400	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>F</sub> =-20A			-1.5	V

#### Notes

1. The test condition is VDD=-20V,VGS=-10V,L=0.5mH,IAS=-34A

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